

To our customers,

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## Old Company Name in Catalogs and Other Documents

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On April 1<sup>st</sup>, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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# DATA SHEET



## BIPOLAR ANALOG INTEGRATED CIRCUIT

# $\mu$ PC451GR-9LG, $\mu$ PC324GR-9LG

### SINGLE POWER SUPPLY QUAD OPERATIONAL AMPLIFIERS

#### <R> DESCRIPTION

The  $\mu$ PC451GR-9LG,  $\mu$ PC324GR-9LG are quad operational amplifiers which are designed to operate for a single power supply. It includes features of low-voltage operation, a common-mode input voltage that range from  $V^-$  (GND) level, an output from a  $V^-$  (GND) level that is determined by the output stage of class C push-pull circuit and a 50  $\mu$ A(TYP.) constant current, and a low current consumption.

In addition, this can operate at both positive and negative power supply and it can be extensively used in various amplifier circuits.

The  $\mu$ PC451GR-9LG which expands temperature type is suited for wide operating ambient temperature use, and  $\mu$ PC324GR-9LG is used for general purposes.

A DC parameter selection that is compatible to operational amplifiers is also available.

$\mu$ PC1251GR-9LG,  $\mu$ PC1251MP-KAA,  $\mu$ PC358GR-9LG which are dual types with the same circuit configuration are also available as series of operational amplifiers.

#### <R> FEATURES

- Input Offset Voltage  $\pm 2$  mV (TYP.)
- Input Offset Current  $\pm 5$  nA (TYP.)
- Large Signal Voltage Gain 100000 (TYP.)
- Small Package (The mounting area is reduced to half compared to the conventional 14-pin plastic SOP (1.27 mm pitch))
- Internal frequency compensation
- Output short-circuit protection

#### <R> ORDERING INFORMATION

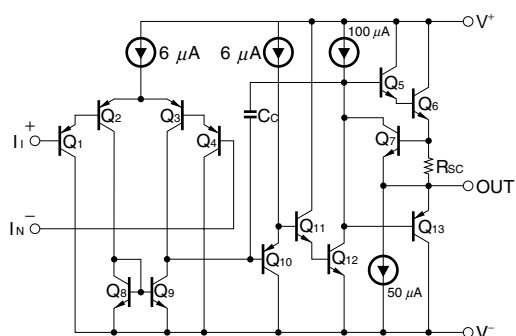
Part Number	Selected Grade	Package	Package Type
$\mu$ PC451GR-9LG-E1-A <sup>Note</sup>	Standard	14-pin plastic TSSOP (5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 on draw-out side
$\mu$ PC451GR-9LG-E2-A <sup>Note</sup>	Standard	14-pin plastic TSSOP (5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 at take-up side
$\mu$ PC451GR(5)-9LG-E1-A <sup>Note</sup>	DC parameter selection	14-pin plastic TSSOP (5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 on draw-out side
$\mu$ PC451GR(5)-9LG-E2-A <sup>Note</sup>	DC parameter selection	14-pin plastic TSSOP (5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 at take-up side
$\mu$ PC324GR-9LG-E1-A <sup>Note</sup>	Standard	14-pin plastic TSSOP(5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 on draw-out side
$\mu$ PC324GR-9LG-E2-A <sup>Note</sup>	Standard	14-pin plastic TSSOP(5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 at take-up side
$\mu$ PC324GR(5)-9LG-E1-A <sup>Note</sup>	DC parameter selection	14-pin plastic TSSOP(5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 on draw-out side
$\mu$ PC324GR(5)-9LG-E2-A <sup>Note</sup>	DC parameter selection	14-pin plastic TSSOP(5.72 mm(225))	• 16 mm wide embossed taping • Pin 1 at take-up side

**Note** Pb-free (This product does not contain Pb in the external electrode and other parts.)

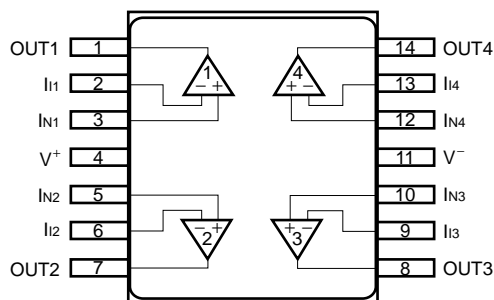
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EQUIVALENT CIRCUIT (1/4 Circuit)



<R> PIN CONFIGURATION (Marking side)



<R> ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Parameter	Symbol	$\mu$ PC451GR-9LG, $\mu$ PC451GR(5)-9LG	$\mu$ PC324GR-9LG, $\mu$ PC324GR(5)-9LG	Unit
Voltage between V <sup>+</sup> and V <sup>-</sup> <sup>Note1</sup>	V <sup>+</sup> - V <sup>-</sup>	-0.3 to +32		V
Differential Input Voltage	V <sub>ID</sub>	±32		V
Input Voltage <sup>Note2</sup>	V <sub>I</sub>	V <sup>-</sup> - 0.3 to V <sup>-</sup> + 32		V
Output applied Voltage <sup>Note3</sup>	V <sub>O</sub>	V <sup>-</sup> - 0.3 to V <sup>+</sup> + 0.3		V
Total Power Dissipation <sup>Note4</sup>	P <sub>T</sub>	550		mW
Output Short Circuit Duration <sup>Note5</sup>	t <sub>s</sub>	Indefinite		s
Operating Ambient Temperature	T <sub>A</sub>	-40 to +125	-40 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	-55 to +125	°C

**Note1.** Note that reverse connections of the power supply may damage ICs.

2. The input voltage is allowed to input without damage or destruction independent of the magnitude of V<sup>+</sup>. Either input signal is not allowed to go negative by more than 0.3 V. In addition, the input voltage that operates normally as an operational amplifier is within the Common Mode Input Voltage range of an electrical characteristic.
3. A range where input voltage can be applied to an output pin externally with no deterioration or damage to the feature (characteristic). The input voltage can be applied regardless of the electric supply voltage. This specification which includes the transition state such as electric power ON/OFF must be kept.
4. This is the value of when the glass epoxy substrate (size: 100 mm x 100 mm, thickness: 1 mm, 15% of the substrate area where only one side is copper foiled is filling wired) is mounted.

Note that restrictions will be made to the following conditions for each product, and the derating ratio depending on the operating ambient temperature.

$\mu$ PC451GR-9LG: Derate at -7.0 mW/°C when T<sub>A</sub> > 71°C.

(Junction - ambient thermal resistance R<sub>th(J-A)</sub> = 144°C/W)

$\mu$ PC324GR-9LG: Derate at -7.0 mW/°C when T<sub>A</sub> > 46°C.

(Junction - ambient thermal resistance R<sub>th(J-A)</sub> = 144°C/W)

5. V<sup>+</sup> ≤ +15 V, 1 arbitrary channel only. Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, **Note 4**.

**RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Power Supply Voltage (Split)	$V^{\pm}$	±1.5		±15	V
Power Supply Voltage ( $V^- = \text{GND}$ )	$V^+$	+3		+30	V

<R> **ELECTRICAL CHARACTERISTICS**

**μPC451GR-9LG, μPC324GR-9LG ( $T_A = 25^{\circ}\text{C}$ ,  $V^+ = +5\text{ V}$ ,  $V^- = \text{GND}$ )**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	$V_{IO}$	$R_S = 0\ \Omega$		±2	±7	mV
Input Offset Current	$I_{IO}$			±5	±50	nA
Input Bias Current <sup>Note1</sup>	$I_B$			15	250	nA
Large Signal Voltage Gain	$A_V$	$R_L \geq 2\ \text{k}\Omega$	25000	100000		
Circuit Current <sup>Note2</sup>	$I_{CC}$	$R_L = \infty$ , $I_O = 0\ \text{A}$		1.2	2.0	mA
Common Mode Rejection Ratio	CMR		65	85		dB
Supply Voltage Rejection Ratio	SVR		65	100		dB
Output Voltage Swing	$V_O$	$R_L = 2\ \text{k}\Omega$ (Connect to GND)	0		$V^+ - 1.5$	V
Common Mode Input Voltage Range	$V_{ICM}$		0		$V^+ - 1.5$	V
Output Source Current	$I_{O\ \text{SOURCE}}$	$V_{IN(+)} = +1\ \text{V}$ , $V_{IN(-)} = 0\ \text{V}$	20	40		mA
Output Sink Current	$I_{O\ \text{SINK1}}$	$V_{IN(-)} = +1\ \text{V}$ , $V_{IN(+)} = 0\ \text{V}$	10	20		mA
	$I_{O\ \text{SINK2}}$	$V_{IN(-)} = +1\ \text{V}$ , $V_{IN(+)} = 0\ \text{V}$ , $V_O = 200\ \text{mV}$	12	50		μA
Channel Separation		$f = 1\ \text{to}\ 20\ \text{kHz}$		120		dB

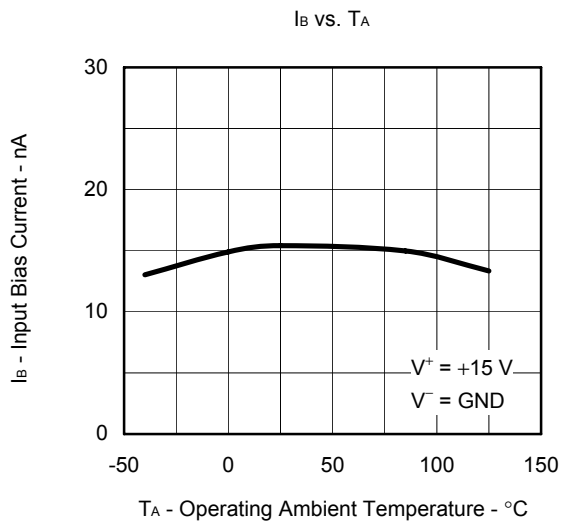
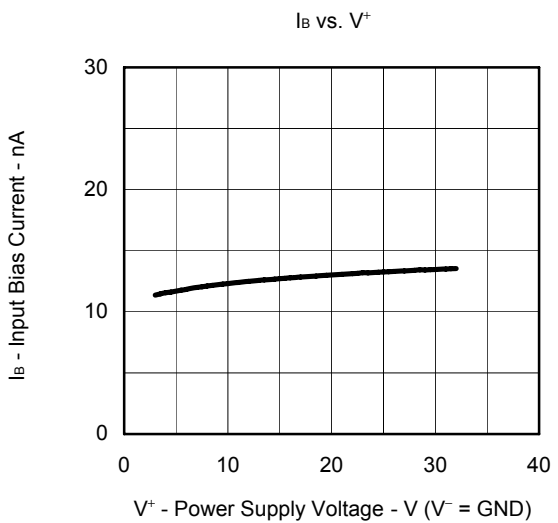
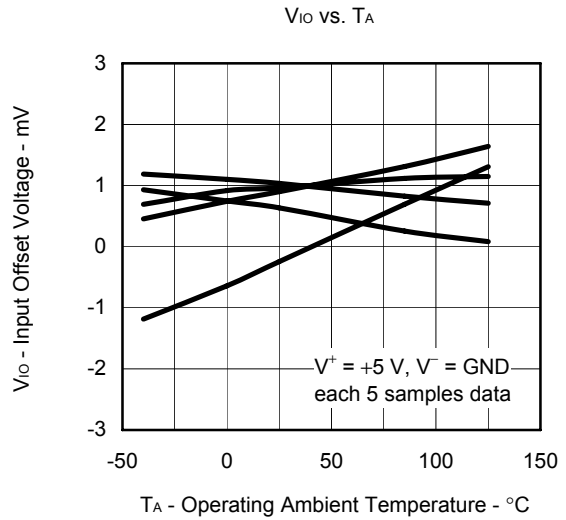
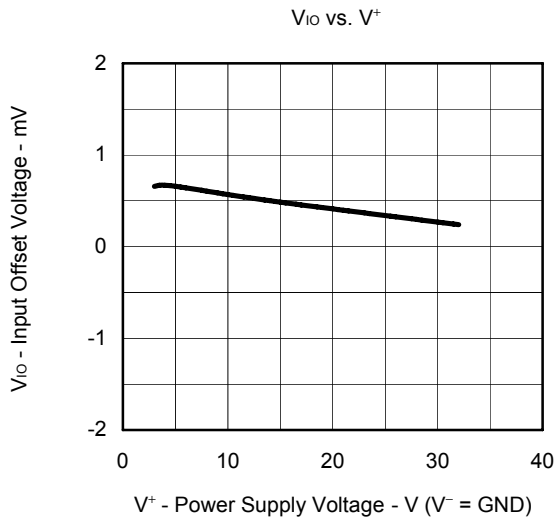
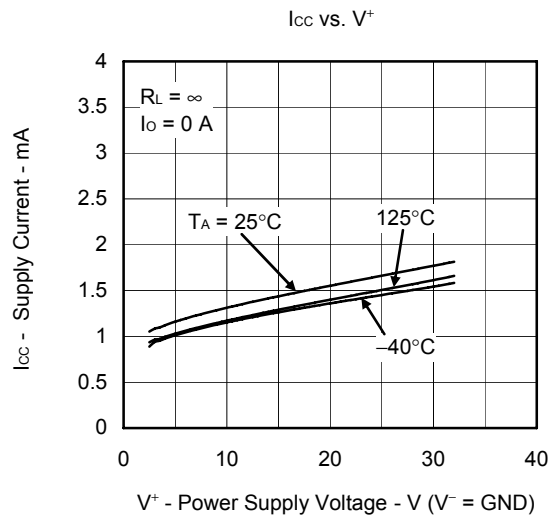
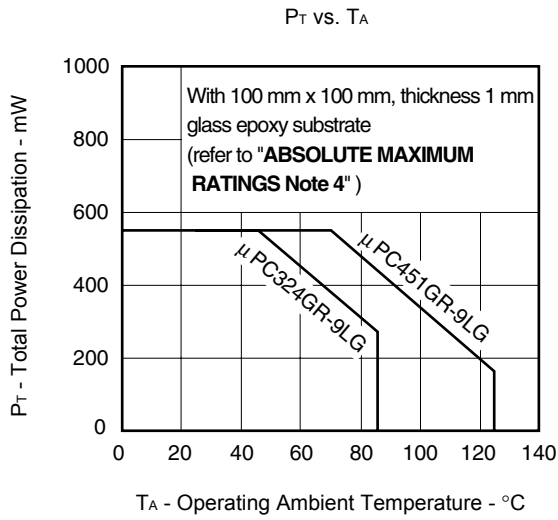
**μPC451GR(5)-9LG, μPC324GR(5)-9LG ( $T_A = 25^{\circ}\text{C}$ ,  $V^+ = +5\ \text{V}$ ,  $V^- = \text{GND}$ )**

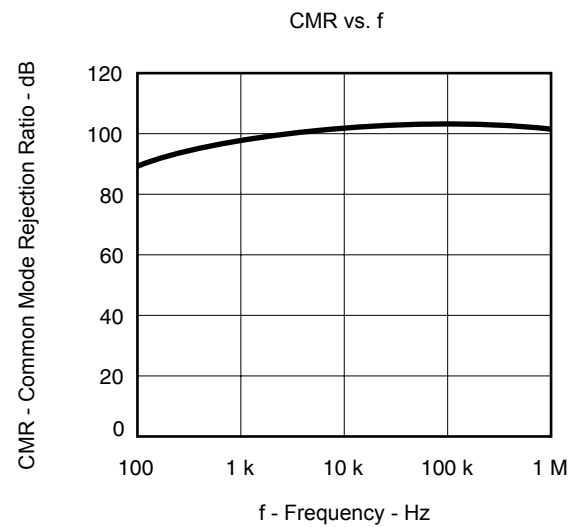
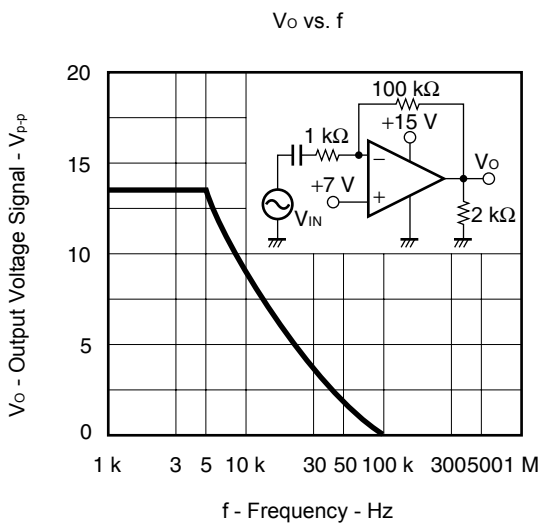
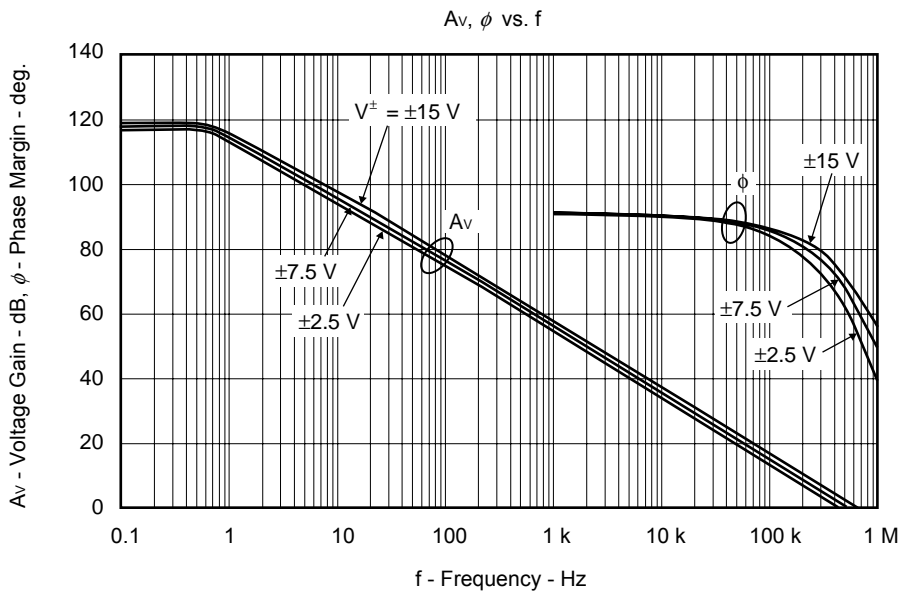
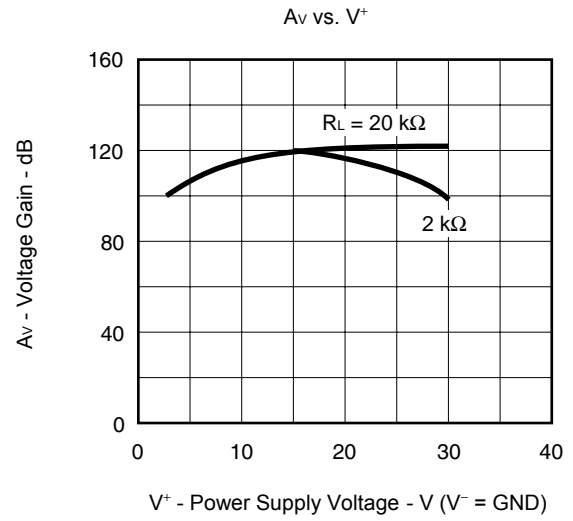
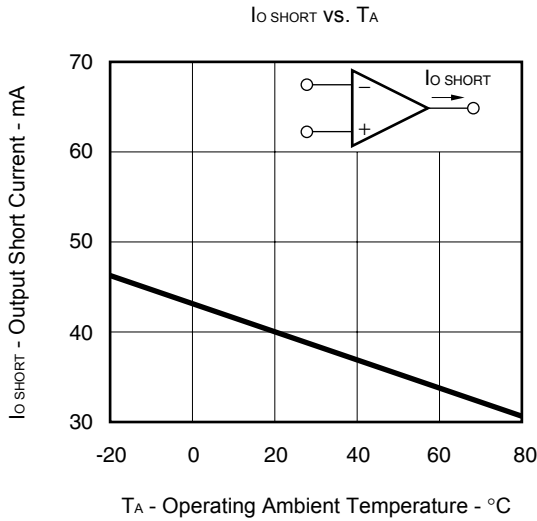
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	$V_{IO}$	$R_S = 0\ \Omega$		±2	±3	mV
Input Offset Current	$I_{IO}$			±5	±50	nA
Input Bias Current <sup>Note1</sup>	$I_B$			15	60	nA
Large Signal Voltage Gain	$A_V$	$R_L \geq 2\ \text{k}\Omega$	50000	100000		
Circuit Current <sup>Note2</sup>	$I_{CC}$	$R_L = \infty$ , $I_O = 0\ \text{A}$		1.2	1.5	mA
Common Mode Rejection Ratio	CMR		65	85		dB
Supply Voltage Rejection Ratio	SVR		65	100		dB
Output Voltage Swing	$V_O$	$R_L = 2\ \text{k}\Omega$ (Connect to GND)	0		$V^+ - 1.5$	V
Common Mode Input Voltage Range	$V_{ICM}$		0		$V^+ - 1.4$	V
Output Source Current	$I_{O\ \text{SOURCE}}$	$V_{IN(+)} = +1\ \text{V}$ , $V_{IN(-)} = 0\ \text{V}$	30	40		mA
Output Sink Current	$I_{O\ \text{SINK1}}$	$V_{IN(-)} = +1\ \text{V}$ , $V_{IN(+)} = 0\ \text{V}$	15	20		mA
	$I_{O\ \text{SINK2}}$	$V_{IN(-)} = +1\ \text{V}$ , $V_{IN(+)} = 0\ \text{V}$ , $V_O = 200\ \text{mV}$	30	50	70	μA
Channel Separation		$f = 1\ \text{to}\ 20\ \text{kHz}$		120		dB

**Notes1.** The input bias current flows in the direction where the IC flows out because the first stage is configured with a PNP transistor.

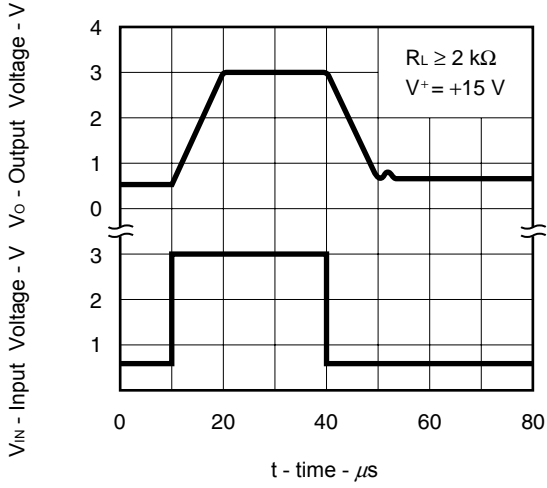
**2.** This is a current that flows in the internal circuit. This current will flow irrespective of the channel used.

<R> TYPICAL PERFORMANCE CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , TYP.) (Reference value)

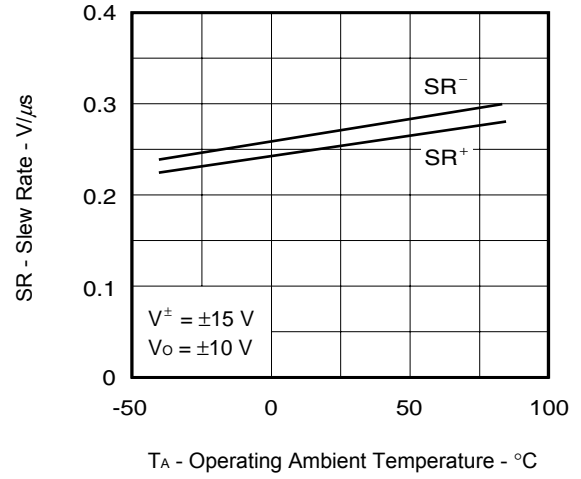




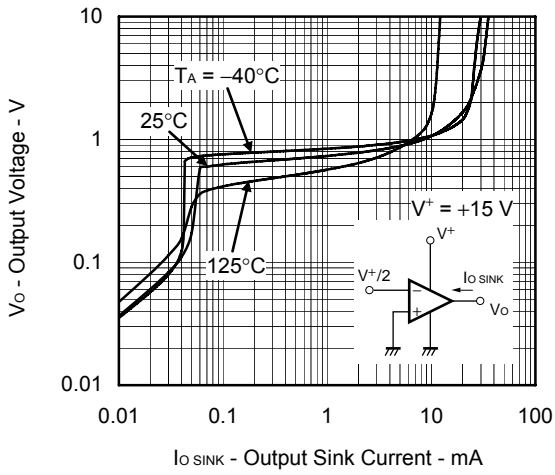
PULSE RESPONSE



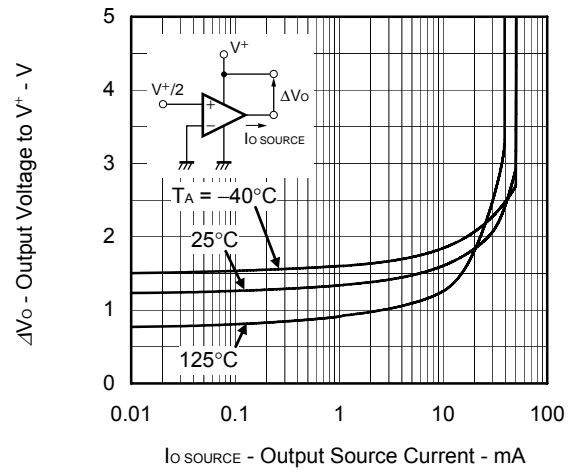
SR -  $T_A$



$V_O$  vs.  $I_O$  SINK



$\Delta V_O$  vs.  $I_O$  SOURCE



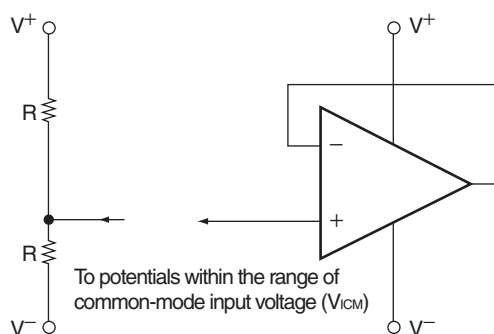


<R> PRECAUTIONS FOR USE

**O The process of unused circuits**

If there is an unused circuit, the following connection is recommended.

**Process example of unused circuits**



**Remark** A midpoint potential of  $V^+$  and  $V^-$  is applied to this example.

**O Ratings of input/output pin voltage**

When the voltage of input/output pin exceeds the absolute maximum rating, it may cause degradation of characteristics or damages, by a conduction of a parasitic diode within an IC. In addition, when the input pin may be lower than  $V^-$ , or the output pin may exceed the power supply voltage, it is recommended to make a clamp circuit by a diode whose forward voltage is low (e.g.: Schottky diode) for protection.

**O Range of common-mode input voltage**

When the supply voltage does not meet the condition of electrical characteristics, the range of common-mode input voltage is as follows.

$V_{ICM}$  (TYP.):  $V^-$  to  $V^+ - 1.5$  (V) ( $T_A = 25^\circ\text{C}$ )

During designing, temperature characteristics for use with allowance.

**O The maximum output voltage**

The range of the TYP. value of the maximum output voltage when the supply voltage does not meet the condition of electrical characteristics is as follows:

$V_{Om^+}$  (TYP.):  $V^+ - 1.5$  (V) ( $T_A = 25^\circ\text{C}$ ),  $V_{Om^-}$  (TYP.) ( $I_{o\text{ SINK}} \leq 50 \mu\text{A}$ ): Approx.  $V^-$  (V) ( $T_A = 25^\circ\text{C}$ )

During designing, consider variations in characteristics and temperature characteristics for use with allowance.

In addition, also note that the output voltage range ( $V_{Om^+} - V_{Om^-}$ ) becomes narrow when an output current increases.

**O Operation of output**

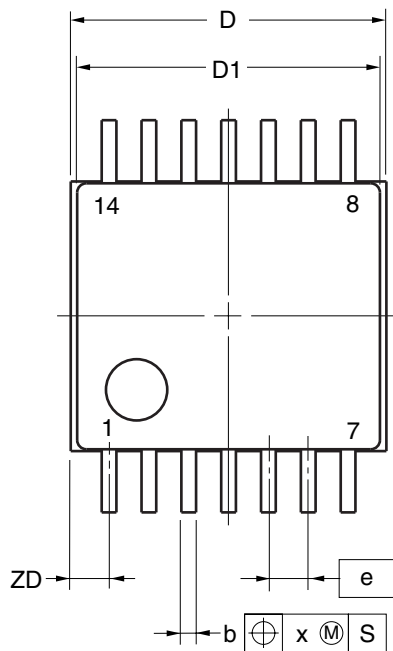
This IC consist an output level of a class C push-pull. Therefore, when a load resistance is connected to the midpoint potential of  $V^+$ ,  $V^-$ , a crossover distortion occurs at the transition state of output current flow direction (source, sink).

**O Handling of ICs**

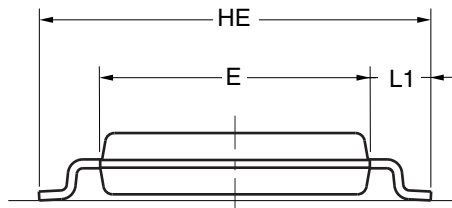
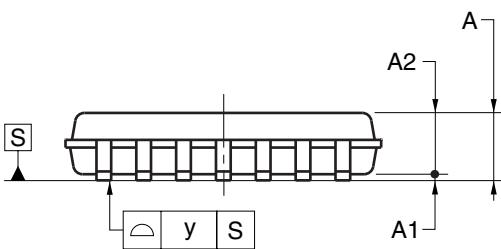
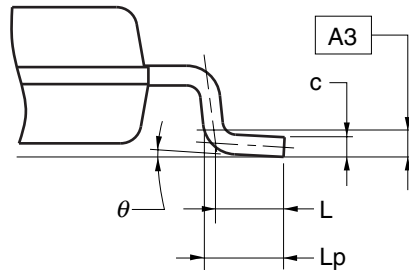
When stress is added to ICs due to warpage or bending of a board, the characteristic fluctuates due to piezoelectric effect. Therefore, pay attention to warpage or bending of a board.

PACKAGE DRAWINGS (Unit: mm)

14-PIN PLASTIC TSSOP (5.72mm (225))



detail of lead end



(UNIT:mm)

ITEM	DIMENSIONS
D	5.15±0.15
D1	5.00±0.10
E	4.40±0.10
HE	6.40±0.20
A	1.20 MAX.
A1	0.10±0.05
A2	1.00±0.05
A3	0.25
b	0.24 <sup>+0.06</sup> <sub>-0.05</sub>
c	0.145±0.055
L	0.50
Lp	0.60±0.15
L1	1.00±0.20
θ	3° <sup>+5°</sup> <sub>-3°</sub>
e	0.65
x	0.10
y	0.10
ZD	0.625

P14GR-65-9LG

NOTE

Each lead centerline is located within 0.10mm of its true position at maximum material condition.

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<R> **RECOMMENDED SOLDERING CONDITIONS**

The μPC451GR-9LG, μPC324GR-9LG should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

**Semiconductor Device Mount Manual (<http://www.necel.com/pkg/en/mount/index.html>)**

**Type of Surface Mount Device**

μPC451GR-9LG-A<sup>Note</sup>, μPC451GR(5)-9LG-A<sup>Note</sup>,  
 μPC324GR-9LG-A<sup>Note</sup>, μPC324GR(5)-9LG-A<sup>Note</sup>: 14-pin plastic TSSOP (5.72 mm (225))

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 260°C, Reflow time: 60 seconds or less (at 220°C or higher), Maximum number of reflow processes: 3 times.	IR60-00-3
Wave soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120°C or below (Package surface temperature).	WS60-00-1
Partial heating method	Pin temperature: 350°C or below, Heat time: 3 seconds or less (Per each side of the device).	P350

**Note** Pb-free (This product does not contain Pb in external electrode and other parts.)

**Caution** Apply only one kind of soldering condition to a device, except for “partial heating method”, or the device will be damaged by heat stress.

**Remark** Flux: Rosin flux with low chlorine (0.2 Wt% or below) recommended.

<R> **REFERENCE DOCUMENTS**

Document Name	Document No.
QUALITY GRADES ON NEC SEMICONDUCTOR DEVICES	C11531E
SEMICONDUCTOR DEVICE MOUNT MANUAL	<a href="http://www.necel.com/pkg/en/mount/index.html">http://www.necel.com/pkg/en/mount/index.html</a>
NEC SEMICONDUCTOR DEVICE RELIABILITY/QUALITY CONTROL SYSTEM-STANDARD LINEAR IC	IEI-1212
REVIEW OF QUALITY AND RELIABILITY HANDBOOK	C12769E
NEC SEMICONDUCTOR DEVICE RELIABILITY/QUALITY CONTROL SYSTEM	C10983E

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